

TITLE

BASECHASSIS OF SURFACE MOUNTED INDUCTOR

BACKGROUND OF THE INVENTION

1. Field of the Invention

5 The present invention relates to a basechassis of inductor, and more particularly to a basechassis of surface mounted inductor.

2. Description of the Prior Art

10

Generally, the conventional inductor fails to serve as a surface mounted device (SMD) due to the pin-shaped terminals of the coil. A basechassis having strips of stem is required to transform the conventional inductor into a surface mounted
15 device. As shown in Fig.1, the conventional basechassis 20 includes an upper surface and a flat bottom surface (not shown). The upper surface further includes a cavity 21 and two U-shaped metal parts 30 formed on the periphery of the cavity. Each of the metal parts 30 is embedded into the periphery of the
20 basechassis 20 and provides a lower surface to electrically contact with the board.

Still referring to Fig.1, to transform the conventional inductor into a surface mounted inductor 70, the core 11 of the
25 inductor is partially positioned in the cavity 21. Then, a conductive line is wound around the core 11 to form the coil 12. Finally, the pin-shaped terminals of the coil 12 are connected with the metal parts 30, i.e. by welding. After that, the conventional inductor can serve as a surface mounted inductor.

However, the conventional basechassis exhibits the following disadvantages. First, the bottom surface of the conventional surface mounted inductor 70 fails to provide
5 satisfying flatness since the U-shaped metal parts 30 are partially embedded into the basechassis 20. Using welding to connect the coil 12 with the metal parts 30 consumes power and may cause danger. The terminals of the coil originally connecting with the metal parts 30 tend to loosen. The
10 basechassis 20 is made of plastic and thus fragile if the thickness is not enough. However, during trying to increase the thickness to enhance the strength, the profile of the basechassis is inevitably increased. The shape of the conventional surface mounted inductor 70 is symmetrical and the apparatus fails to
15 automatically identify the direction of the magnetic field during using. Therefore, it is confusing and inconvenient. The conventional surface mounted inductor needs additional identification mark, such as the dots 60.

20 Accordingly, there has been a strongly felt need for a novel basechassis for improving the disadvantages described above.

SUMMARY OF THE INVENTION

25 Consideration of the disadvantages of the conventional basechassis described above, the main object of the present invention is to provide an improved basechassis can overcome the aforementioned problems.

30 The present invention discloses a basechassis for transforming an inductor into a surface mounted device. The present inductor includes a core and a coil wound around the core and having two pin-shaped terminals. The basechassis further includes an insulating element (i.e. plastic), a first

conductive element and a second conductive element. The insulating element further includes an upper surface having a cavity and a flat bottom surface.

5 The first conductive element and the second conductive element substantially are Z-shaped and have a strip of first stem and the second stem, respectively. The insulating element exposes the first stem and the portion of the lower surface of the first conductive element. The remaining portion of the first
10 conductive element is embedded into the insulating element. The insulating element exposes the second stem and the portion of the lower surface of the second conductive element. The remaining portion of the second conductive element is embedded into the insulating element. Besides, the exposed lower surface
15 of the first conductive element, the exposed lower surface of the second conductive element and the bottom surface of the basechassis are arranged on the same level. Moreover, one section of the first conductive element extends toward the second stem and further crosses the virtual second cross-sectional
20 line.

 According to the present invention, the core is partially positioned on the first cavity of the basechassis. In addition,
the pin-shaped terminals of the coil are further wound around
25 the stems and so as to form combination. In this manner, the inductor is transformed into a surface mounted inductor by means of the basechassis.

 Compared to prior art, the present invention at least
30 exhibits the advantages described as follows. The bottom surface of the present surface mounted inductor provides satisfying flatness since the exposed lower surface of the first conductive element, the exposed lower surface of the second conductive element and the bottom surface of the basechassis are arranged

on the same level. The terminals of the coil are wound around the conductive elements such that the consumed power for welding is not required. The terminals of the coil wound around the ~~recessed edge~~ notches of the stems are fixed properly. Since the
5 Z-shaped first and second conductive elements are partially embedded into the insulating element, the rigidity of the insulating element is enhanced. Alternatively, the insulating element can be decreased meanwhile keeping the rigidity. The shape of the present surface mounted inductor is unsymmetrical
10 and the direction of the magnetic field can be automatically identified during using. That is, the additional identification mark can be omitted.

Further scope of the applicability of the present invention will become apparent from the detailed description given
15 hereinafter. However, it should be understood that the detailed description and specific examples, while indicating preferred embodiments of the invention, are given by way of illustration only, since various changes and modifications within the spirit and scope of the invention will become apparent to those skilled
20 in the art from this detailed description.

BRIEF DESCRIPTION OF THE DRAWINGS

25 The foregoing aspects and many of the attendant advantages of this invention will become more readily appreciated as the same becomes better understood by reference to the following detailed description, when taken in conjunction with the accompanying drawings, which are given by way of illustration
30 only, and thus are not limitative of the present invention, and wherein:

Fig.1 depicts a conventional basechassis used in a surface mounted inductor ;

Fig.2 depicts the basechassis having the inductor formed thereon according to the present invention ;

Fig.3(a) depicts the exploded view illustrating the basechassis according to the present invention ;

Fig.3(b) depicts the top plan view illustrating the basechassis according to the present invention ;

Fig.4(a) depicts the side view illustrating the basechassis according to the present invention ; and

Fig.4(b) depicts the partially amplified side view illustrating the basechassis according to the present invention.

DESCRIPTION OF THE PREFERRED EMBODIMENT

The present invention discloses a basechassis 200 for transforming an inductor into a surface mounted device. As shown in Fig.2, the present inductor 100 includes a core 110 and a coil 120. The coil 120 is wound around the core 110 and thus has two pin-shaped terminals 125. The basechassis 200 includes an upper surface having a first cavity 210 and strips of stems 550 and 650. The first cavity 210 accommodates a part of the inductor 100 (i.e. the bottom surface of the core 110). Besides, the pin-shaped terminals 125 are further wound around the stems 550 and 650 so as to form combination. In this manner, the inductor

is transformed into a surface mounted inductor 700 by means of the basechassis 200.

Referring to Fig.2 and Fig.3(a), the basechassis 200 further
5 includes an insulating element 300, a first conductive element 500 and a second conductive element 600. The insulating element 300 further includes an upper surface and a flat bottom surface (not shown). As described above, the upper surface has a first cavity 210 accommodating the bottom surface of the core 110 of
10 the inductor 100. Among these, the bottom surface of the basechassis 200 is flat and attached to a board (not shown) during using.

Referring to Fig.3(b), the first conductive element 500
15 further includes a first section 510, a second section 520 and a first ~~bend-section~~step section 530. The second conductive element 600 further includes a third section 610, a fourth section 620 and a second ~~bend-section~~step section 630. Among these, the first section 510, the first ~~bend-section~~step section
20 530, the third section 610 and the second ~~bend-section~~step section 630 is embedded into (i.e. by molding) the insulating element 300. The second section 520 and the fourth section 620 are formed on the periphery of the insulating element 300. Additionally, the second section 520 and the fourth section 620
25 further include a strip of first stem 550 and a second stem 650, respectively. The insulating element 300 exposes the first stem 550 and the second stem 650. The insulating element 300 also exposes the lower surfaces of the second section 520 and the fourth section 620, explained in greater detail below. That is,
30 the second section 520 and the fourth section 620 are partially embedded into the insulating element 300.

Still referring to Fig.3(b), note that the basechassis 200 is unsymmetrical basechassisd on a view along the first

cross-sectional line, such as the horizontal cross-sectional line AA' passing through the center of the ~~base~~chassis 200. To expose the first stem 550 and the second stem 650, the upper portion and the lower portion of the insulating element 300 separated by the cross-sectional line AA' are unsymmetrical to each other. Among these, the exposed first stem 550 and the second stem 650 are located on the lower portion. Therefore, according to the present invention, the desired direction of the magnetic field can be previously determined automatically, rather than manually, during assembling. Besides, the present invention can be packaged in a tape reel and meanwhile oriented toward the same direction by a suitable container matching the shape of the present inductor formed on the tape reel. Because the present inductor fails to be packaged in the tape reel if an incorrect orientation is given. Contrary to the present invention, it is unable to identify the desired direction of the magnetic field of the conventional inductor automatically during assembling since the conventional inductor is symmetrical. In this case, the desired orientations of the conventional inductors packaged in a tape reel tend to be confused, which cause inconvenience. For example, the desired direction of the magnetic field of the conventional inductors packaged in a tape reel may be oriented toward the different directions. The above-mentioned first cross-sectional line may be a virtual line extending from the second section 520 to the fourth section 620. Besides, the first cross-sectional line is perpendicular to the second cross-sectional line, such as the cross-sectional line BB' shown in Fig.3(b). The second cross-sectional line extends from the first section 510 to the third section 610. Besides, the two portions of the insulating element 300 separated by the second cross-sectional line, such as the right portion and the left portion, are mirror symmetrical.

Still referring to Fig.3(b), the first stem 550 further includes at least one ~~recessed edge~~notch 555. The second stem 650 further includes at least one ~~recessed edge~~notch 655. As described above, the terminals of the coil of the inductor 100
5 shown in Fig.2 are further wound around the ~~recessed edge~~notches 555 of the first stem 550 and the ~~recessed edge~~notches 655 of the second stem 650, thereby enhancing the combination. Even though the first stem 550 and the second stem 650 are bent, the terminals of the coil wound around the first stem 550 and the second stem
10 650 will not loosen. Therefore, according to the present invention, combining the terminals of the coil with the first stem 550 and the second stem 650 does not require welding.

Still referring to Fig.3(b), in the first conductive element
15 500, the first section 510 connects with the second section 520 through the first ~~bend section~~step section 530. Similarly, in the second conductive element 600, the third section 610 connects with the fourth section 620 through the second ~~bend section~~step section 630. Therefore, as the top plan view shown in Fig.3(b),
20 the first conductive element 500 and the second conductive element 600 substantially are Z-shaped. Moreover, the third section 610 extends toward the first stem 550 and further crosses the second cross-sectional line BB'. The first section 510 extends toward the fourth section 620 and further crosses the
25 second cross-sectional line BB'. As such, the first section 510 and the third section 610 enable the ~~base~~chassis 200 to resist the bending force along or parallel to the second cross-sectional line, such as the cross-sectional line BB'. Alternatively, the strength of the ~~base~~chassis 200 is enhanced enough and meanwhile
30 the profile of the insulating element is thus reduced.

Refer to Fig.4(a) showing the side view illustrating the first conductive element 500 and the second conductive element 600. Obviously, as shown in the dotted line, there is a drop

formed between the first ~~bend section~~step section 530 and the second section 520. Besides, there is also a drop formed between the second ~~bend section~~step section 630 and the fourth section 620. Alternatively, the level of the second section 520 is lower than the level of the first ~~bend section~~step section 530. Besides, the insulating element 300 exposes the lower surface of the second section 520. Similarly, the level of the fourth section 620 is lower than the level of the second section 630. The insulating element 300 exposes the lower surface of the fourth section 620. Note that the lower surface of the second section 520, the lower surface of the fourth section 620 and the bottom surface of the ~~base~~chassis 200 are arranged on the same level. As such, the second section 520 and the fourth section 620 electrically contact the board having the ~~base~~chassis 200 mounted thereon. Therefore, the first section 510 and the third section 610 are far away from the board and form isolation therebetween.

Referring to Fig.3(b) and Fig.4(b) which shows the partially amplified side view illustrating the first or second conductive element, there is at least one second cavity 570 formed on the upper surfaces and the lower surfaces of the first conductive element 500 and the second conductive element 600, respectively. The second cavity 570 enables the clamp holder 800 to clamp the first conductive element 500 or the second conductive element 600 during molding. As such, the first conductive element 500 and the second conductive element 600 can resist the impact and thus be fixed properly during molding. The clamp holder 800 is removed after molding.

30

As is understood by a person skilled in the art, the foregoing preferred embodiments of the present invention are illustrated of the present invention rather than limiting of the present invention. It is intended to cover various modifications and

similar arrangements included within the spirit and scope of the appended claims, the scope of which should be accorded the broadest interpretation so as to encompass all such modifications and similar structure.